

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

**CONVEYING PARTY DATA**

Name	Execution Date
Yufeng Yao	10/08/2010
Chi Boon Ong	10/08/2010
Chee Heng Wong	10/08/2010

**RECEIVING PARTY DATA**

Name:	AVAGO TECHNOLOGIES ECBU IP (SINGAPORE) PTE. LTD.
Street Address:	NO. YISHUN AVE. 7
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	768923

**PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	12901037

**CORRESPONDENCE DATA**

Fax Number: (970)288-0617  
*Correspondence will be sent via US Mail when the fax attempt is unsuccessful.*  
 Phone: 970-288-0731  
 Email: avagoip@system.foundationip.com  
 Correspondent Name: Avago Technologies Limited  
 Address Line 1: 4380 Ziegler Road  
 Address Line 4: Fort Collins, COLORADO 80525

ATTORNEY DOCKET NUMBER:	2010-069USORG
NAME OF SUBMITTER:	Adrienne Barclay

Total Attachments: 4  
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**CH \$40.00 12901037**

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**PATENT  
 REEL: 025116 FRAME: 0959**

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AVAGO TECHNOLOGIES  
4380 Ziegler Road  
Fort Collins, CO 80525

ATTORNEY DOCKET NO. 2010-069USORG

ASSIGNMENT OF PATENT APPLICATION TO AVAGO TECHNOLOGIES  
ECBU IP (SINGAPORE) PTE. LTD.

I/We the undersigned (each) have agreed and hereby agree to assign to Avago Technologies EBCU IP (Singapore) Pte. Ltd. (Company Registration No. 200512325K), a company incorporated under the laws of Singapore whose registered office is at No. 1 Yishun Avenue 7, Singapore 768923 (hereinafter AVAGO), in furtherance of my/our obligations to AVAGO, and do hereby assign and transfer to AVAGO, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States entitled:

PACKAGE-ON-PACKAGE PROXIMITY SENSOR MODULE

Filing date: 8 Oct 2010 Serial No.: 12/901,037

and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (C-I-P's), divisionals, and renewals of and substitutes for said application for Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor; and any reissues, or reexaminations, or extensions of said Letters Patents.

I/We additionally authorize AVAGO to file applications in my/our name for Letters Patent in any country, to be held and enjoyed by AVAGO, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

AND I/we hereby covenant that I/we have full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Letters Patent, to AVAGO, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to AVAGO, or to its nominee, all known facts respecting said invention(s) or improvement(s), said application and said Letters Patents, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, C-I-P's, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid AVAGO, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) in any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by AVAGO;

AND I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to AVAGO, as assignee of the entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment.

I/we further authorize and direct AVAGO attorneys to insert the serial number and filing date of said application now identified by the attorney docket number and title set forth above as soon as the same shall have been made known to them by the United States Patent and Trademark Office.

IN WITNESS WHEREOF, I/we hereunto set my/our hand(s) and seal(s):

  
\_\_\_\_\_  
Inventor's Signature (Seal)

Date Assignment Signed: 08/10/2010

Inventor's Typed Name: Yao, Yufeng


Date Application Signed: 08/10/2010

\_\_\_\_\_  
Inventor's Signature (Seal)

Date Assignment Signed: \_\_\_\_\_

Inventor's Typed Name: Ong, Chi Boon

Date Application Signed: \_\_\_\_\_

  
Inventor's Signature (Seal)

Date Assignment Signed: 08/10/2010

Inventor's Typed Name: Wong, Chee Heng

Date Application Signed: 08/10/2010

APPLICATION

AVAGO TECHNOLOGIES  
4380 Ziegler Road  
Fort Collins, CO 80525

ATTORNEY DOCKET NO. 2010-069USORG

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PACKAGE-ON-PACKAGE PROXIMITY SENSOR MODULE

Filing date: 8 Oct 2010 Serial No.: 12/901,037

and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (C-I-P's), divisionals, and renewals of and substitutes for said application for Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor; and any reissues, or reexaminations, or extensions of said Letters Patents.

I/We additionally authorize AVAGO to file applications in my/our name for Letters Patent in any country, to be held and enjoyed by AVAGO, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

AND I/we hereby covenant that I/we have full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Letters Patent, to AVAGO, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to AVAGO, or to its nominee, all known facts respecting said invention(s) or improvement(s), said application and said Letters Patents, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, C-I-P's, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid AVAGO, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) in any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by AVAGO;

AND I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to AVAGO, as assignee of the entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment.

I/we further authorize and direct AVAGO attorneys to insert the serial number and filing date of said application now identified by the attorney docket number and title set forth above as soon as the same shall have been made known to them by the United States Patent and Trademark Office.

IN WITNESS WHEREOF, I/we hereunto set my/our hand(s) and seal(s):

\_\_\_\_\_  
Inventor's Signature (Seal)

Date Assignment Signed: \_\_\_\_\_

Inventor's Typed Name: Yao, Yufeng

Date Application Signed: \_\_\_\_\_



8 Oct 10

\_\_\_\_\_  
Inventor's Signature (Seal)

Date Assignment Signed: \_\_\_\_\_

Inventor's Typed Name: Ong, Chi Boon

Date Application Signed: \_\_\_\_\_

8 Oct 10

Page 1 of 2

\_\_\_\_\_  
Inventor's Signature (Seal)

Date Assignment Signed: \_\_\_\_\_

Inventor's Typed Name: Wong, Chee Heng

Date Application Signed: \_\_\_\_\_

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